54ACT16475, 74ACT16475 18-BIT REGISTERED TRANSCEIVERS WITH 3-STATE OUTPUTS

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- **Members of the Texas Instruments** Widebus™ Family
- Inputs Are TTL-Voltage Compatible
- 3-State Inverting Outputs
- Flow-Through Architecture Optimizes **PCB Layout**
- Distributed V_{CC} and GND Pin Configuration **Minimizes High-Speed Switching Noise**
- **EPIC™** (Enhanced-Performance Implanted CMOS) 1-µm Process
- 500-mA Typical Latch-Up Immunity at 125°C
- Packaged in Plastic 300-mil Shrink Small-Outline (DL) Packages Using 25-mil Center-to-Center Pin Spacings and 380-mil Fine-Pitch Ceramic Flat (WD) Packages **Using 25-mil Center-to-Center Pin Spacings**

description

The 'ACT16475 are 18-bit registered transceivers that contain two sets of D-type flip-flops for temporary storage of data flowing in either direction. They can be used as two 9-bit transceivers or one 18-bit transceiver. Separate clock (CLKAB and CLKBA) and output-enable (OEAB or OEBA) inputs are provided for each register to permit independent control in either direction of data flow.

Data at the A inputs meeting the setup time requirements is transferred to the B outputs on the positive-going edge of CLKAB. With OEAB low, the 3-state B outputs are enabled and reflect the inverted A data. Data flow from B to A is similar but requires the use of the CLKBA and OEBA inputs.

54ACT16475...WD PACKAGE 74ACT16475 . . . DL PACKAGE (TOP VIEW)

1		_	
1OEAB	₁ O	56	1OEBA
1CLKAB[2	55] 1CLKBA
1A1[3	54] 1B1
GND[4	53] GND
1A2[5	52] 1B2
1A3[6	51] 1B3
V _{CC} [7	50] V _{CC}
_	8	49] 1B4
1A5[9	48] 1B5
1A6[10	47] 1B6
GND[11	46] GND
1A7[12	45] 1B7
1A8[13	44] 1B8
1A9[14	43] 1B9
2A1[15	42] 2B1
2A2[16	41] 2B2
2A3[17	40] 2B3
GND[18	39] GND
2A4[19	38] 2B4
2A5[20	37] 2B5
2A6[21	36] 2B6
V _{CC} [22	35] V _{CC}
2A7[23	34] 2B7
2A8[24	33] 2B8
GND[25	32] GND
2A9[26	31] 2B9
2CLKAB[27	30	2CLKBA
2OEAB	28	29	2 <mark>OEBA</mark>

The 74ACT16475 is packaged in TI's shrink small-outline package, which provides twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The 54ACT16475 is characterized for operation over the full military temperature range of -55°C to 125°C. The 74ACT16475 is characterized for operation from -40°C to 85°C.



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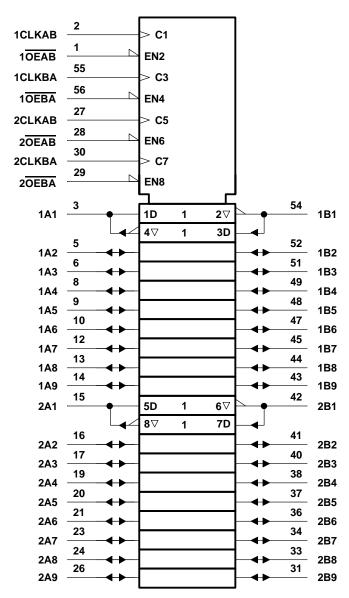


FUNCTION TABLE†

	INPUTS					
OEAB	CLKAB	Α	В			
Н	Х	Х	Z			
L	L	Χ	в ₀ ‡ Н			
L	\uparrow	L	Н			
L	\uparrow	Н	L			

[†] A-to-B data flow is shown: B-to-A flow is similar but uses CLKBA and OEBA.

logic symbol§

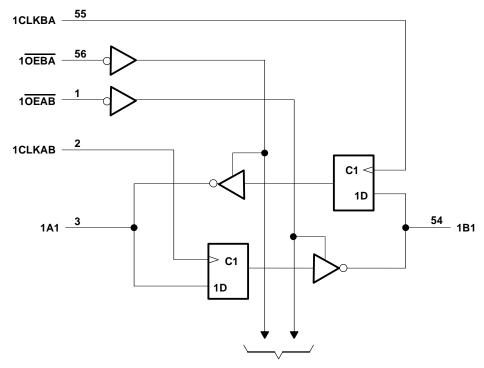


§ This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

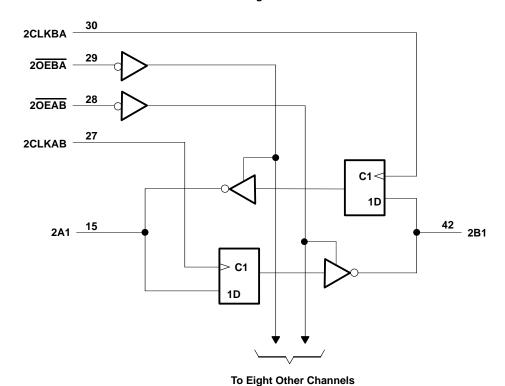


[‡]Output level before the indicated steady-state input conditions were established

logic diagram (positive logic)



To Eight Other Channels





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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V _{CC}	\dots –0.5 V to 7 V
Input voltage range, V _I (see Note 1)–0.5	$V \text{ to V}_{CC} + 0.5 \text{ V}$
Input voltage range, V _O (see Note 1)–0.5	$V \text{ to V}_{CC} + 0.5 \text{ V}$
Input clamp current, I_{IK} ($V_I < 0$ or $V_I > V_{CC}$)	±20 mA
Output clamp current, I _{OK} (V _O < 0 or V _O > V _{CC})	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±50 mA
Continuous current through V _{CC} or GND	±450 mA
Maximum power package dissipation at T _A = 55°C (in still air) (see Note 2): DL package .	1.4 W
Storage temperature range, T _{Sto}	. −65°C to 150°C

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 2)

		54	ACT164	75	74ACT16475			UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage	2		7	2			V
V _{IL}	Low-level input voltage		Š	0.8			0.8	V
٧ _I	Input voltage	0	PA	VCC	0		VCC	V
٧o	Output voltage	0	1/	VCC	0		VCC	V
loh	High-level output current		3	-24			-24	mA
loL	Low-level output current	20,	5	24			24	mA
Δt/Δν	Input transition rise or fall rate	0		10	0		10	ns/V
T _A	Operating free-air temperature	- 55		125	-40		85	°C

NOTE 3: Unused pins (input or I/O) must be held high or low to prevent them from floating.

NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^{2.} The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS	V	T,	_Δ = 25°C	;	54ACT	16475	74ACT	16475	UNIT
FAI	RAWETER	TEST CONDITIONS	Vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
		I _{OH} = -50 μA	4.5 V	4.4			4.4		4.4		
		ΙΟΗ = -50 μΑ	5.5 V	5.4			5.4		5.4		
Vон		1011 - 24 mA	4.5 V	3.94			3.8		3.8		V
		$I_{OH} = -24 \text{ mA}$	5.5 V	4.94			4.8		4.8		
		$I_{OH} = -75 \text{ mA}^{\dagger}$	5.5 V				3.85	N.	3.85		
		I _{OL} = 50 μA	4.5 V			0.1		0.1		0.1	
		ΙΟΣ = 30 μΑ	5.5 V			0.1	4	0.1		0.1	
VOL		la. – 24 mA	4.5 V			0.36	√ 3	0.44		0.44	V
		I _{OL} = 24 mA	5.5 V			0.36	20	0.44		0.44	
		I _{OL} = 75 mA [†]	5.5 V				O _W	1.65		1.65	
П	Control inputs	V _I = V _{CC} or GND	5.5 V			±0.1	y	±1		±1	μΑ
loz‡	A or B ports	$V_O = V_{CC}$ or GND	5.5 V			±0.5		±5		±5	μΑ
Icc		$V_I = V_{CC}$ or GND, $I_O = 0$	5.5 V			8		80		80	μΑ
Δl _{CC} §		One input at 3.4 V, Other inputs at V _{CC} or GND	5.5 V			0.9		1		1	mA
Ci	Control inputs	V _I = V _{CC} or GND	5 V		4.5					, and the second	pF
C _{io}	A or B ports	$V_O = V_{CC}$ or GND	5 V		12						pF

[†] Not more than one output should be tested at a time, and the duration of the test should not exceed 10 ms.

timing requirements over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

				T _A = 25°C		54ACT16475		74ACT16475	
			MIN	MAX	MIN	MAX	MIN	MAX	UNIT
fclock	Clock frequency		0	75	0	75	0	75	MHz
t _W	Pulse duration	CLK high or low	6.5		6.5	1000	6.5		ns
t _{su}	Setup time	Data before CLK↑	5.5		5.5	110	5.5		ns
th	Hold time	Data after CLK↑	1.5		1,5		1.5		ns

switching characteristics over recommended operating free-air temperature range, V_{CC} = 5 V \pm 0.5 V (unless otherwise noted) (see Figure 1)

PARAMETER	FROM	то	T _A = 25°C			54ACT	16475	74ACT16475		UNIT
PARAMETER	(INPUT)	(OUTPUT)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT
f _{max}			75			75	'S	75		MHz
tPLH	CLKAB or CLKBA	B or A	3.8	7.9	11.1	3.8	12.5	3.8	12.5	20
t _{PHL}	CLKAB OF CLKBA	BUIA	4.2	8.1	11.4	4.2	12.6	4.2	12.6	ns
^t PZH	<u> </u>	B or A	2.8	7.3	11.4	2.8	12.8	2.8	12.8	20
t _{PZL}	OEAB or OEBA	BUIA	3.4	7.4	13.1	3.4	14.8	3.4	14.8	ns
^t PHZ	OFAR - OFRA	B or A	5.2	6.5	9.8	5.2	10.5	5.2	10.5	no
t _{PLZ}	OEAB or OEBA	BUIA	4.5	6.6	9.1	4.5	9.8	4.5	9.8	ns



[‡] For I/O ports, the parameter IOZ includes the input leakage current.

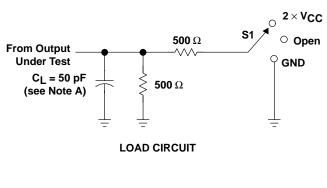
[§] This is the increase in supply current for each input that is at one of the specified TTL voltage levels rather than 0 V or VCC.

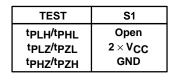
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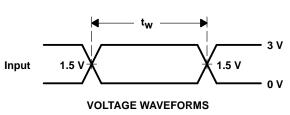
operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

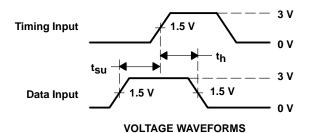
PARAMETER			TEST CO	TYP	UNIT	
C . Dougs dissination conseitance not transceives	Outputs enabled	$C_1 = 50 pF$	f = 1 MHz	27	ηE	
Cpd	Power dissipation capacitance per transceiver	Outputs disabled	CL = 50 pr,	I = I IVITZ	9	ρг

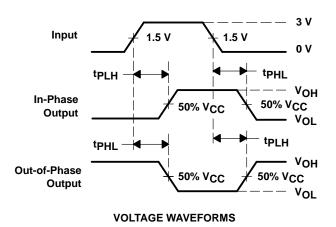
PARAMETER MEASUREMENT INFORMATION

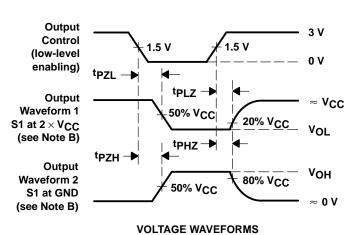












NOTES: A. C_L includes probe and jig capacitance.

- Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control.
 Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_f = 3 \text{ ns}$, $t_f = 3 \text{ ns}$.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms



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